HCPL-2201, HCPL-2202, HCPL-2211, HCPL-2212, HCPL-2231, HCPL-2232, HCPL-0201, HCPL-0211, HCNW2201, HCNW2211



Very High CMR, Wide V_{cc} Logic Gate Optocouplers

Data Sheet

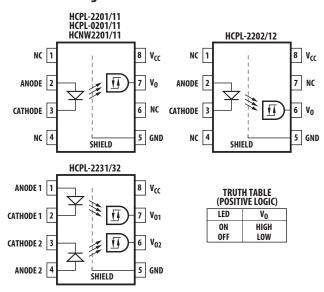


Description

The HCPL-22XX, HCPL-02XX, and HCNW22XX are optically-coupled logic gates. The HCPL-22XX, and HCPL-02XX contain a GaAsP LED while the HCNW22XX contains an AlGaAs LED. The detectors have totem pole output stages and optical receiver input stages with built-in Schmitt triggers to provide logic-compatible waveforms, eliminating the need for additional waveshaping.

A superior internal shield on the HCPL-2211/12, HCPL-0211, HCPL-2232 and HCNW2211 guarantees common mode transient immunity of 10 kV/ μ s at a common mode voltage of 1000 volts.

Functional Diagram



A 0.1 µF bypass capacitor must be connected between pins 5 and 8.

Features

- 10 kV/µs minimum Common Mode Rejection (CMR) at V_{CM} = 1000 V (HCPL-2211/2212/0211/2232, HCNW2211)
- Wide operating V_{CC} range: 4.5 to 20 Volts
- 300 ns propagation delay guaranteed over the full temperature range
- 5 Mbd typical signal rate
- Low input current (1.6 mA to 1.8 mA)
- Hysteresis
- Totem pole output (no pullup resistor required)
- Available in 8-Pin DIP, SOIC-8, widebody packages
- Guaranteed performance from -40°C to 85°C
- Safety approval
 - UL recognized -3750 V rms for 1 minute (5000 V rms for 1 minute for HCNW22XX) per UL1577
 - CSAapproved
 - IEC/EN/DIN EN 60747-5-5 approved with V $_{\rm IORM}$ = 630 V $_{\rm peak}$ (HCPL-2211/2212 Option 060 only) and V $_{\rm IORM}$ = 1414 V $_{\rm peak}$ (HCNW22XX only)
- MIL-PRF-38534 hermetic version available (HCPL-52XX/62XX)

Applications

- Isolation of high speed logic systems
- Computer-peripheral interfaces
- Microprocessor system interfaces
- Ground loop elimination
- Pulse transformer replacement
- High speed line receiver
- Power control systems

CAUTION: It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD. The components featured in this datasheet are not to be used in military or aerospace applications or environments.

The electrical and switching characteristics of the HCPL-22XX, HCPL-02XX and HCNW22XX are guaranteed from -40°C to +85°C and a V_{cc} from 4.5 volts to 20 volts. Low $I_{\rm F}$ and wide V_{cc} range allow compatibility with TTL, LSTTL, and CMOS logic and result in lower power consumption compared to other high speed couplers. Logic signals are transmitted with a typical propagation delay of 150 ns.

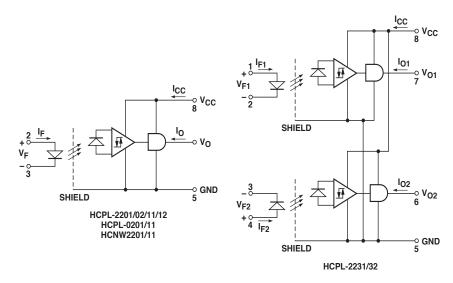
Selection Guide

Minimum	CMRInput	8-Pin	DIP (300 Mil)		Small- Outline SO-8	Widebody (400 Mil)	Hermetic
dV/dt (V/μs)	V _{cM} (V)	On- Current (mA)	Single Channel Package	Dual Channel Package	Single Channel Package	Single Channel Package	Single and Dual Channel Packages
1,000	50	1.6	HCPL-2200 ^[1,2] HCPL-2201 HCPL-2202		HCPL-0201	HCNW2201	
		1.8		HCPL-2231			
2,500	400	1.6	HCPL-2219 ^[1,2]				
5,000[3]	300[3]	1.6	HCPL-2211 HCPL-2212		HCPL-0211	HCNW2211	
		1.8		HCPL-2232			
1,000	50	2.0					HCPL-52XX ^[2] HCPL-62XX ^[2]

Notes:

- 1. HCPL-2200/2219 devices include output enable/disable function.
- 2. Technical data for the HCPL-2200/2219, HCPL-52XX and HCPL-62XX are on separate Avago publications.
- 3. Minimum CMR of 10 kV/ μ s with $V_{CM} = 1000$ V can be achieved with input current, $I_{p'}$ of 5 mA.

Schematic



Ordering Information

HCPL-2201, HCPL-2202, HCPL-2211, HCPL-2212, HCPL-2231, HCPL-2232, HCPL-0201, HCPL-0211 are UL Recognized with 3750 Vrms for 1 minute per UL1577.

HCNW2201 and HCNW2211 are UL Recognized with 5000 Vrms for 1 minute per UL1577.

All devices listed above are approved under CSA Component Acceptance Notice #5, File CA 88324.

	Ор	tion					UL 5000		
Part number	RoHS Compliant	Non RoHS Compliant	Package	Surface Mount	Gull Wing	Tape & Reel	Vrms/ 1 Minute rating	IEC/EN/DIN EN 60747-5-5	Quantity
	-000E	No option							50 per tube
HCPL-2201	-300E	#300		X	Χ				50 per tube
HCPL-2202	-500E	#500	300mil DIP-8	X	Χ	Χ			1000 per reel
HCPL-2211	-060E	#060						Х	50 per tube
HCPL-2212	-360E	#360		X	Х			Х	50 per tube
	-560E	#560		X	Х	Х		Х	1000 per reel
	-000E	No option							50 per tube
HCPL-2231 HCPL-2232	-300E	#300		X	Х				50 per tube
TICI L 2232	-500E	#500		X	Х	Х			1000 per reel
	-000E	No option		Х					100 per tube
HCPL-0201	-500E	#500	60.0	X		Х			1500 per reel
HCPL-0211	-060E	#060	SO-8	X				Χ	100 per tube
	-560E	#560		X		Х		Х	1500 per reel
	-000E	No option	400mil				Х	Х	42 per tube
HCNW2201 - HCNW2211 -	-300E	#300	Widebody	X	Х		Х	Х	42 per tube
TCNVV2211	-500E	#500	DIP-8	X	Х	Х	Х	Х	750 per reel

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

HCPL-2202-560E to order product of 300mil DIP Gull Wing Surface Mount package in Tape and Reel packaging with IEC/EN/DIN EN 60747-5-5 Safety Approval in RoHS compliant.

Example 2:

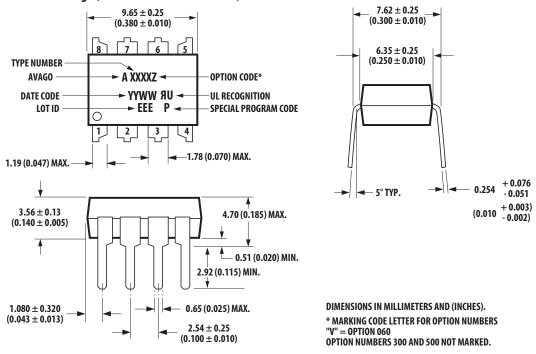
HCPL-2202 to order product of 300mil DIP package in tube packaging and non RoHS compliant.

Option datasheets are available. Contact your Avago sales representative or authorized distributor for information.

Remarks: The notation '#XXX' is used for existing products, while (new) products launched since 15th July 2001 and RoHS compliant option will use '-XXXE'.

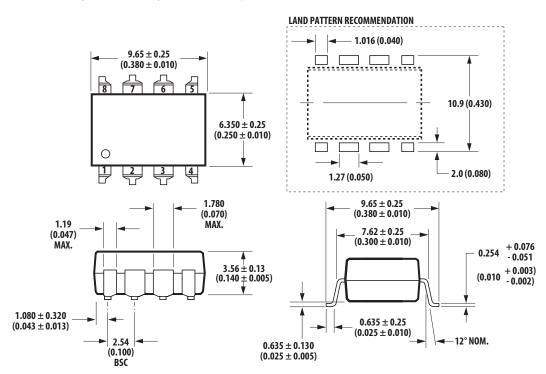
Package Outline Drawings

8-Pin DIP Package (HCPL-2201/02/11/12/31/32)



NOTE: FLOATING LEAD PROTRUSION IS 0.25 mm (10 mils) MAX.

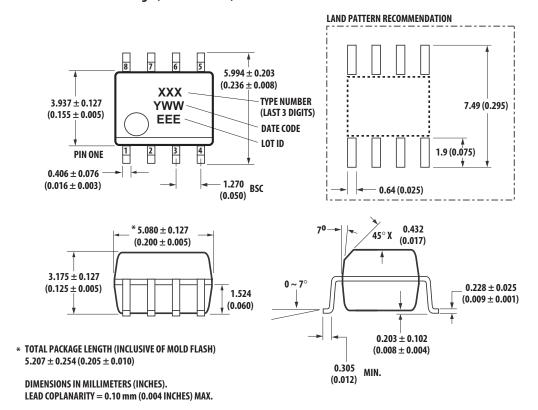
8-Pin DIP Package with Gull Wing Surface Mount Option 300 (HCPL-2201/02/11/12/31/32)



DIMENSIONS IN MILLIMETERS (INCHES).
LEAD COPLANARITY = 0.10 mm (0.004 INCHES).

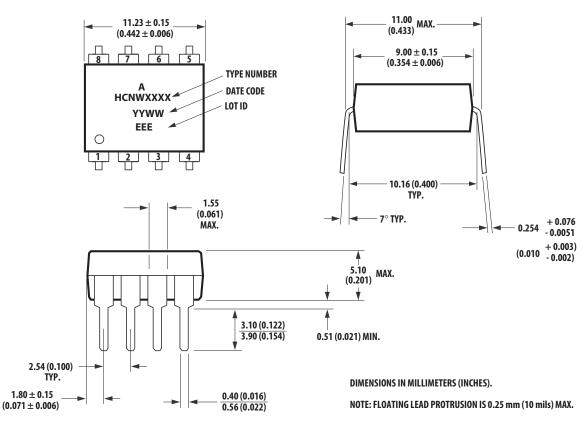
NOTE: FLOATING LEAD PROTRUSION IS 0.25 mm (10 mils) MAX.

Small-Outline SO-8 Package (HCPL-0201/11)

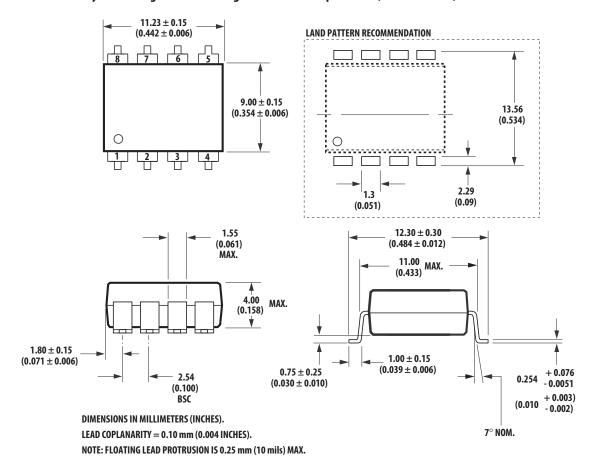


NOTE: FLOATING LEAD PROTRUSION IS 0.15 mm (6 mils) MAX.

8-Pin Widebody DIP Package (HCNW2201/11)



8-Pin Widebody DIP Package with Gull Wing Surface Mount Option 300 (HCNW2201/11)



Solder Reflow Profile

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision). Non-Halide Flux should be used.

Regulatory Information

The HCPL-22XX/02XX and HCNW22XX have been approved by the following organizations:

UL Recognized under UL 1577, Component Recognition Program, File E55361.

CSA Approved under CSA Component Acceptance Notice #5, File CA 88324.

IEC/EN/DIN EN 60747-5-5 (Option 060 and HCNW only)

Insulation and Safety Related Specifications

8-pin DIP Package

Parameter	Symbol	8-Pin DIP (300 Mil) Value	SO-8 Value	Widebody (400 Mil) Value	Units	Conditions
Minimum External Air Gap (External Clearance)	L(101)	7.1	4.9	9.6	mm	Measured from input terminals to output terminals, shortest distance through air.
Minimum External Tracking (External Creepage)	L(102)	7.4	4.8	10.0	mm	Measured from input terminals to output terminals, shortest distance path along body.
Minimum Internal Plastic Gap (Internal Clearance)		0.08	0.08	1.0	mm	Through insulation distance, conductor to conductor, usually the direct distance between the photoemitter and photodetector inside the optocoupler cavity.
Minimum Internal Tracking (Internal Creepage)		NA	NA	4.0	mm	Measured from input terminals to output terminals, along internal cavity.
Tracking Resistance (Comparative Tracking Index)	CTI	200	200	200	Volts	DIN IEC 112/VDE 0303 Part 1
Isolation Group		Illa	Illa	Illa		Material Group (DIN VDE 0110, 1/89, Table 1)

Option 300 - surface mount classification is Class A in accordance with CECC 00802.

IEC/EN/DIN EN 60747-5-5 Insulation Characteristics (Option 060)

Description	Symbol	Characteristic HCPL-2201/02/ 11/12/31/32	HCPL- 0201/11	Unit
Installation classification per DIN VDE 0110, Table 1				
for rated mains voltage ≤ 150 Vrms		I – IV	I – IV	
for rated mains voltage ≤ 300 Vrms		I - IV	I – IV	
for rated mains voltage \leq 600 Vrms		I – IV	I – III	
Climatic Classification		0/70/21	0/70/21	
Pollution Degree (DIN VDE 0110/39)		2	2	
Maximum Working Insulation Voltage	V _{IORM}	630	567	V_{peak}
Input to Output Test Voltage, Method b* $V_{IORM} \times 1.875 = V_{PR'} 100\%$ Production Test with $t_m = 1$ sec, Partial discharge < 5 pC	$V_{_{PR}}$	1181	1063	V_{peak}
Input to Output Test Voltage, Method a* $V_{IORM} \times 1.6 = V_{PR'}$ Type and Sample Test, $t_m = 10$ sec, Partial discharge < 5 pC	V_{PR}	1008	907	V_{peak}
Highest Allowable Overvoltage (Transient Overvoltage $t_{ini} = 60$ sec)	V_{IOTM}	8000	6000	V_{peak}
Safety-limiting values (Maximum values allowed in the event of a failure, also see Figure 12, Thermal Derating curve.)				
Case Temperature	T_s	175	150	°C
Input Current	I _{S. INPUT}	230	230	mA
Output Power	P _{s, OUTPUT}	600	600	mW
Insulation Resistance at TS, V _{IO} = 500 V	R _s	≥109	≥10 ⁹	Ω

IEC/EN/DIN EN 60747-5-5 Insulation Characteristics (HCNW22xx Option 060 ONLY)

Description	Symbol	Characteristic	Unit
Installation classification per DIN VDE 0110, Table 1			
for rated mains voltage ≤ 150 Vrms		I – IV	
for rated mains voltage ≤ 300 Vrms		I – IV	
for rated mains voltage ≤ 600 Vrms		I – IV	
for rated mains voltage ≤ 1000 Vrms		I – III	
Climatic Classification		-40/85/21	
Pollution Degree (DIN VDE 0110/39)		2	
Maximum Working Insulation Voltage	V _{IORM}	1414	V _{peak}
Input to Output Test Voltage, Method b*	V _{PR}	2651	V _{peak}
$V_{\text{IORM}} \times 1.875 = V_{\text{PR}}$, 100% Production Test with $t_{\text{m}} = 1$ sec, Partial discharge < 5 pC	rn		реак
Input to Output Test Voltage, Method a*	$V_{_{\mathrm{PR}}}$	2262	V_{peak}
$V_{\text{IORM}} \times 1.6 = V_{\text{PR}}$, Type and Sample Test, $t_{\text{m}} = 10$ sec, Partial discharge < 5 pC	rn		peak
Highest Allowable Overvoltage* (Transient Overvoltage t _{ini} = 60 sec)	V _{IOTM}	8000	V _{peak}
Safety-limiting values			
(Maximum values allowed in the event of a failure, also see Figure 12, Thermal			
Derating curve.)			
Case Temperature	T_s	150	°C
Input Current	I _{s, INPUT}	400	mA
Output Power	P _{s, output}	700	mW
Insulation Resistance at TS, V _{IO} = 500 V	R _s	≥10 ⁹	Ω

^{*} Refer to the front of the optocoupler section of the current catalog, under Product Safety Regulations section IEC/EN/DIN EN 60747-5-5, for a detailed description.

 $Note: Isolation \ \dot{c} haracteristics \ are \ guaranteed \ only \ within \ the \ safety \ maximum \ ratings \ which \ must \ be \ ensured \ by \ protective \ circuits \ in \ application.$

Absolute Maximum Ratings

Parameter		Symbol	Min.	Max.	Units	Note
Storage Temperature		T _s	-55	125	°C	
Operating Temperature		T _A	-40	85	°C	
Average Forward Input Current		I _{F(AVG)}		10	mA	1
Peak Transient Input Current (≤ 1 µs Pulse Width, 300 pps)		I _{F(TRAN)}		1.0	А	1
(≤ 200 μs Pulse Width, < 1% Duty Cycle)	HCNW22XX			40	mA	
Reverse Input Voltage		$V_{_{\rm R}}$		5	V	1 1 1 1 2 1 2 Dlane
	HCNW22XX			3		
Average Output Current		I _o		25	mA	1
Supply Voltage		V _{CC}	0	20	V	
Output Voltage		V _o	-0.5	20	V	1
Total Package Power Dissipation		P _T		210	mW	2
	HCPL-223X			294		
Output Power Dissipation		P _o	See Figu	re 7		1
Lead Solder Temperature (Through Hole Parts Only)			260°C fo 1.6 mm l	r 10 sec., pelow seating	ı plane	
	HCNW22XX		260°C fo	r 10 sec., up to	seating pla	
Solder Reflow Temperature Profile (Surface Mount Parts Only)			See Pack	age Outline [Drawings sec	tion

Recommended Operating Conditions

Parameter		Symbol	Min.	Max.	Units
Power Supply Voltage		V _{cc}	4.5	20	V
Forward Input Current (ON)		I _{F(ON)}	1.6*	5	mA
	HCPL-223X		1.8†		
Forward Input Voltage (OFF)		V _{F(OFF)}	-	0.8	V
Operating Temperature		T _A	-40	85	°C
Junction Temperature		T _J	-40	125	°C
Fan Out		N		4	TTL Loads

^{*}The initial switching threshold is 1.6 mA or less. It is recommended that 2.2 mA be used to permit at least a 20% LED degradation guardband. †The initial switching threshold is 1.8 mA or less. It is recommended that 2.5 mA be used to permit at least a 20% LED degradation guardband.

Electrical Specifications

 $-40^{\circ}\text{C} \le \text{T}_{A} \le 85^{\circ}\text{C}$, $4.5 \text{ V} \le \text{V}_{CC} \le 20 \text{ V}$, $1.6 \text{ mA} \le \text{I}_{F(ON)}^{*} \le 5 \text{ mA}$, $0 \text{ V} \le \text{V}_{F(OFF)} \le 0.8 \text{ V}$, unless otherwise specified. All Typicals at $\text{T}_{A} = 25^{\circ}\text{C}$. See Note 7.

Parameter		Sym.	Min.	Тур.	Max.	Units	Test Conditi	ionsFig.	Note	Fig
Logic Low Ou	tput Voltage	V _{OL}			0.5	V	I _{OL} = 6.4 mA (4 TT	L Loads)	1, 3	1
Logic High Ou	ıtput Voltage	V _{OH}	2.4	**		V	I _{OH} = -2.6 mA		2, 3,	1
$(V_{OUT} < V_{CC})$			2.7				I _{OH} = -0.4 mA		-	
Output Leaka	ge Current	I _{OHH}			100	μΑ	V _o = 5.5 V	$I_F = 5 \text{ mA}$		1
		. –			500		V _o = 20 V		•	
Logic Low Supply		I _{CCL}		3.7	6.0	mA	V _{cc} = 5.5 V	$V_F = 0 V$		
Current				4.3	7.0		V _{CC} = 20 V	I _o = Open		
	HCPL-223X			7.4	12.0		V _{cc} = 5.5 V	_		
				8.6	14.0		V _{CC} = 20 V			
Logic High Supply		I _{CCH}		2.4	4.0	mA	V _{cc} = 5.5 V	$I_F = 5 \text{ mA}$		
Current				2.7	5.0		V _{CC} = 20 V	I _o = Open		
	HCPL-223X			4.8	8.0		V _{CC} = 5.5 V			
				5.4	10.0		V _{CC} = 20 V			
Logic Low Sho	ort Circuit	I _{OSL}	15			mA	$V_{o} = V_{cc} = 5.5 \text{ V}$	$V_F = 0 V$		1, 3
Output Curren	ī		20				$V_{o} = V_{cc} = 20 \text{ V}$	$V_0 = GND$	•	
Logic High Sh		I _{OSH}			-10	mA	V _{cc} = 5.5 V	$I_F = 5 \text{ mA}$		1, 3
Output Currer	nt				-20		V _{CC} = 20 V		-	
Input Forward	l Voltage	V _F		1.5	1.7	V	T _A = 25°C	$I_F = 5 \text{ mA}$	4	1
					1.85				_	
	HCNW22XX			1.5	1.82		T _A = 25°C		_	
					1.95				_	
Input Reverse	Breakdown	BV_{R}	5			V	$I_R = 10 \mu A$			1
Voltage	HCNW22XX		3				$I_R = 100 \mu\text{A}$		_	
Input Diode T	emperature	$\Delta V_{_{\rm F}}$		-1.7		mV/°C	$I_F = 5 \text{ mA}$			
Coefficient	HCNW22XX	ΔT_A		-1.4					_	
Input Capacita	ance	C _{IN}		60		pF	$f = 1 \text{ MHz}, V_F = 0 $	/	1, 4	
	HCNW22XX			70					_	

^{*}For HCPL-223X, 1.8 mA \leq I $_{\text{F(ON)}} \leq$ 5 mA. **Typical V $_{\text{OH}} =$ V $_{\text{CC}}$ - 2.1 V.

Switching Specifications (AC)

 $\begin{array}{l} -40^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq 85^{\circ}\text{C}, \, 4.5 \text{ V} \leq \text{V}_{\text{CC}} \leq 20 \text{ V}, \, 1.6 \text{ mA} \leq \text{I}_{\text{F(ON)}}^{\quad \ *} \leq 5 \text{ mA}, \, 0 \text{ V} \leq \text{V}_{\text{F(OFF)}} \leq 0.8 \text{ V}. \\ \hline \text{All Typicals at T}_{\text{A}} = 25^{\circ}\text{C}, \, \text{V}_{\text{CC}} = 5 \text{ V}, \, \text{I}_{\text{F(ON)}} = 3 \text{ mA unless otherwise specified}. \end{array}$

Parameter	Sym.	Min.	Тур.	Max.	Units	Test Conditions	Fig.	Note
Propagation Delay Time	t _{PHL}		150		ns	Without Peaking Capacitor	5, 6	1, 6
to Logic Low Output Level			160			HCNW22XX		
Output Level			150	300		With Peaking Capacitor		
Propagation Delay Time	t _{PLH}		110		ns	Without Peaking Capacitor	5, 6	1, 6
to Logic High			180			HCNW22XX		
Output Level			90	300		With Peaking Capacitor		
Output Rise Time (10-90%)	t _r		30		ns		5, 9	1
Output Fall Time (90-10%)	t _f		7		ns		5, 9	1

Parameter	Sym.	Device	Min.	Units	Test Condit	ions Fig.	Note	
Logic High Common Mode Transient Immunity	CM _H	HCPL-2201/02 HCPL-0201 HCPL-2231 HCNW2201	1,000	V/µs	$ V_{CM} = 50 \text{ V}$ $I_F = 1.6 \text{ mA}^{\dagger}$	V _{CC} = 5 V T _A = 25°C	10	1, 7
		HCPL-2211/12 HCPL-0211	5,000	V/µs	$ V_{CM} = 300 \text{ V}$ $I_F = 1.6 \text{ mA}^{\ddagger}$	_		
		HCPL-2232 HCNW2211	10,000	V/µs	$ V_{CM} = 1 \text{ kV}$ $I_F = 5.0 \text{ mA}$	_		
Logic Low Common Mode Transient	CM _L	HCPL-2201/02 HCPL-0201 HCPL-2231 HCNW2201	1,000	V/µs	$ V_{CM} = 50 \text{ V}$	$V_F = 0 V$ $V_{CC} = 5 V$ $T_A = 25^{\circ}C$	10	1, 7
		HCPL-2211/12 HCPL-0211 HCPL-2232 HCNW2211	10,000	V/µs	$ V_{CM} = 1 \text{ kV}$	_		

^{*}For HCPL-223X, 1.8 mA \leq I $_{F(ON)}$ \leq 5 mA. †I $_{F}$ = 1.8 mA for HCPL-2231. ‡I $_{F}$ = 1.8 mA for HCPL-2232.

Package Characteristics

Parameter		Sym.	Min.	Тур.	Max.	Units	Test Conditions	Fig.	Note
Input-Output	Momentary	V _{ISO}	3750			V rms	RH < 50%, t = 1 min.		5, 10
Withstand Voltage*	HCNW22XX		5000				T _A = 25°C		5, 11
Input-Output Resistance		R _{I-O}		10 ¹²		Ω	V _{I-O} = 500 Vdc		5
	HCNW22XX		1012	10 ¹³		_	T _A = 25°C		_
			1011				T _A = 100°C		_
Input-Output	Capacitance	C _{I-O}		0.6		рF	f = 1 MHz,		5
	HCNW22XX			0.5	0.6		$T_A = 25^{\circ}C, V_{I-O} = 0 \text{ Vdc}$		_
Input-Input In	sulation	I _{I-I}		0.005		μΑ	Relative Humidity = 45%,		12
Leakage Curre	ent						$t = 5 \text{ s, V}_{I-I} = 500 \text{ V}$		
Resistance (In	Resistance (Input-Input)			10 ¹¹		Ω	V _{I-I} = 500 V		12
Capacitance (Input-Input)		C _{I-I}		0.25		pF	f = 1 MHz		12

^{*}The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to the IEC/EN/DIN EN 60747-5-5 Insulation Characteristics Table (if applicable), your equipment level safety specification or Avago Application Note 1074 entitled "Optocoupler Input-Output Endurance Voltage," publication number 5963-2203

Notes:

- 1. Each channel.
- 2. Derate total package power dissipation, P₁, linearly above 70°C free-air temperature at a rate of 4.5 mW/°C.
- 3. Duration of output short circuit time should not exceed 10 ms.
- 4. For single devices, input capacitance is measured between pin 2 and pin 3.
- 5. Device considered a two-terminal device: pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together.
- 6. The t_{PLH} propagation delay is measured from the 50% point on the leading edge of the input pulse to the 1.3 V point on the leading edge of the output pulse. The t_{PHL} propagation delay is measured from the 50% point on the trailing edge of the input pulse to the 1.3 V point on the trailing edge of the output pulse.
- 7. CM_H is the maximum slew rate of the common mode voltage that can be sustained with the output voltage in the logic high state, $V_o > 2.0 \text{ V}$. CM_H is the maximum slew rate of the common mode voltage that can be sustained with the output voltage in the logic low state, $V_o < 0.8 \text{ V}$.
- 8. For HCPL-2202/12, V_o is on pin 6.
- 9. Use of a 0.1 μF bypass capacitor connected between pins 5 and 8 is recommended.
- 10. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥4500 V rms for one second (leakage detection current limit, I₁₋₀ ≤5 μA). This test is performed before the 100% production test for partial discharge (Method b) shown in the IEC/EN/DIN EN 60747-5-5 Insulation Characteristics Table, if applicable.
- 11. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥6000 V rms for one second (leakage detection current limit, I_{1.0} ≤5 μA). This test is performed before the 100% production test for partial discharge (Method b) shown in the IEC/EN/DIN EN 60747-5-5 Insulation Characteristics Table.
- 12. For HCPL-2231/32 only. Measured between pins 1 and 2, shorted together, and pins 3 and 4, shorted together.

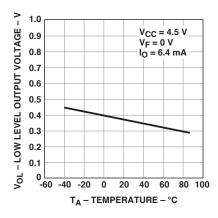


Figure 1. Typical logic low output voltage vs. temperature.

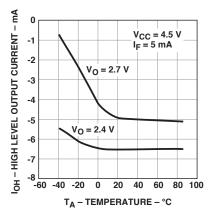


Figure 2. Typical logic high output current vs. temperature.

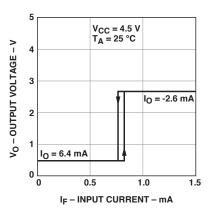
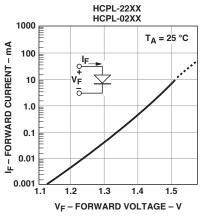


Figure 3. Typical output voltage vs. forward input current.



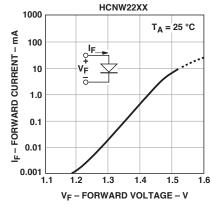


Figure 4. Typical input diode forward characteristic.

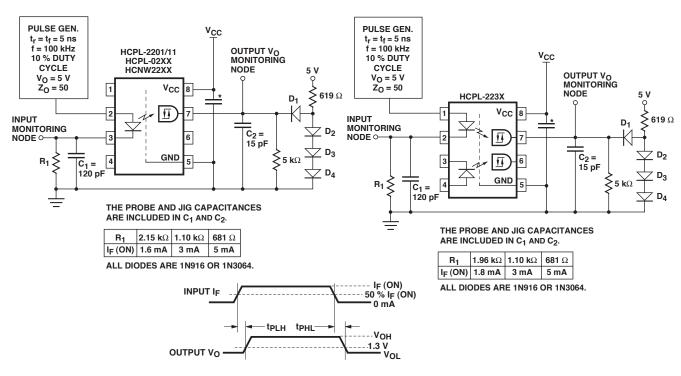


Figure 5. Circuit for $\mathbf{t}_{_{\mathrm{PLH}}}\!,\,\mathbf{t}_{_{\mathrm{PHL}}}\!,\,\mathbf{t}_{_{\mathrm{r}}}\!,\,\mathbf{t}_{_{\mathrm{f}}}$

 * 0.1 μ F BYPASS — SEE NOTE 9.

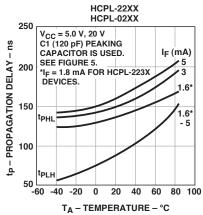


Figure 6. Typical propagation delays vs. temperature.

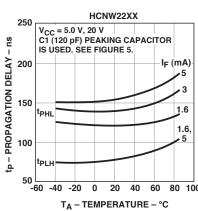


Figure 7. Maximum output power per channel vs. supply voltage.

T_A = 75 °C

T_A = 85 °C

15

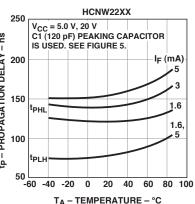
10

V_{CC} - SUPPLY VOLTAGE - V

80

20

P_O – MAXIMUM OUTPUT POWER PER CHANNEL (mW)



V_{OH} – HIGH LEVEL OUTPUT VOLTAGE – V 20 TYPICAL V_{OH} vs. V_{CC} AT I_O = -2.6 mA 15 T_A = 25 °C 10 5 0 10 15 20 V_{CC} - SUPPLY VOLTAGE - V

Figure 8. Typical logic high output voltage vs. supply voltage.

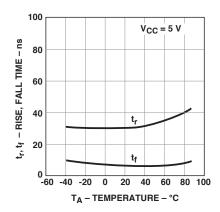


Figure 9. Typical rise, fall time vs. temperature.

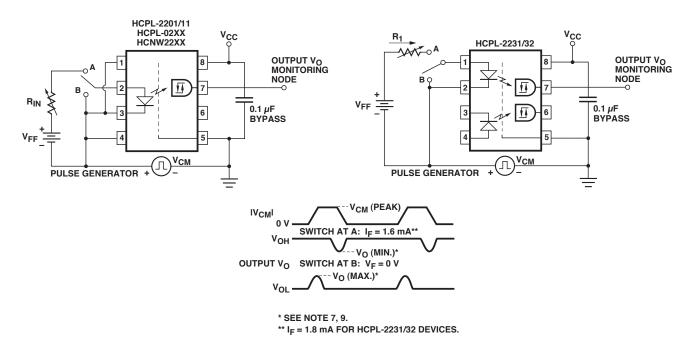


Figure 10. Test circuit for common mode transient immunity and typical waveforms.

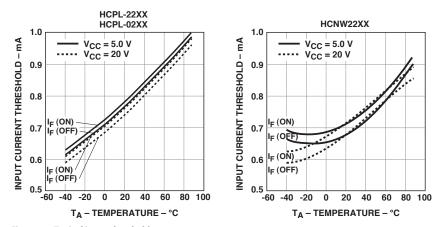


Figure 11. Typical input threshold current vs. temperature.

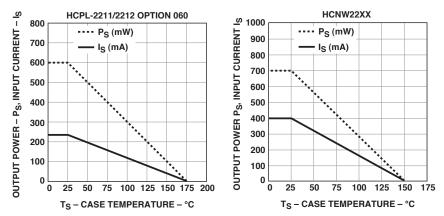


Figure 12. Thermal derating curve, dependence of safety limiting value with case temperature per IEC/EN/DIN EN 60747-5-5.

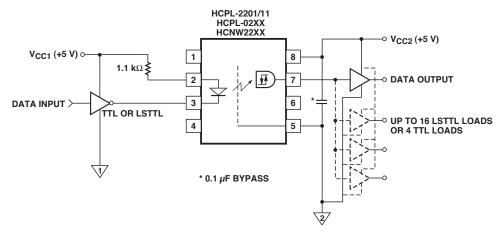


Figure 13a. Recommended LSTTL to LSTTL circuit where 500 ns propagation delay is sufficient.

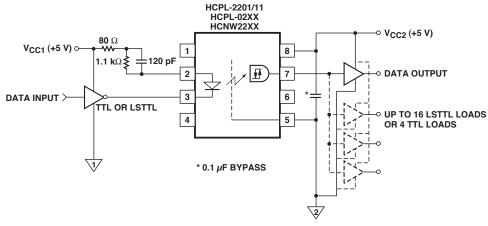


Figure 13b. Recommended LSTTL to LSTTL circuit for applications requiring a maximum allowable propagation delay of 300 ns.

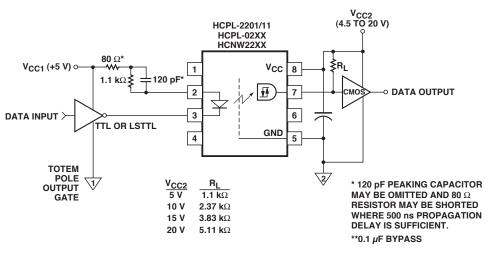


Figure 14. LSTTL to CMOS interface circuit.

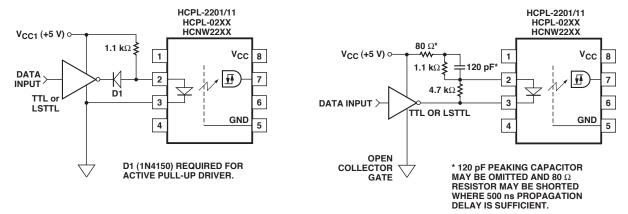


Figure 15. Alternative LED drive circuit.

Figure 16. Series LED drive with open collector gate (4.7 k resistor shunts $I_{\rm op}$ from the LED).

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